

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7758637

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NITTO DENKO	12/27/2022
RECEIVING PARTY DATA	
Name:	K/S HIMPP
Street Address:	NYMOELLEVEJ 6, 3540
City:	LYNGE
State/Country:	DENMARK
PROPERTY NUMBERS Total: 3	
Property Type	Number
Patent Number:	10218223
Patent Number:	11056920
Application Number:	17347277
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	9704921100
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Correspondent Name:	COCHRAN FREUND & YOUNG LLC
Address Line 1:	2026 CARIBOU DRIVE
Address Line 2:	SUITE 201
Address Line 4:	FORT COLLINS, COLORADO 80525
NAME OF SUBMITTER:	MICHELE DIPIETRO
SIGNATURE:	/Michele DiPietro/
DATE SIGNED:	01/24/2023
Total Attachments: 4	
source=NittoDenko20221221_Patent_Assignment_Agreement#page1.tif	
source=NittoDenko20221221_Patent_Assignment_Agreement#page2.tif	
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EXHIBIT B
ASSIGNMENT

ASSIGNMENT AGREEMENT

WHEREAS NITTO DENKO, a corporation organized under the laws of Japan, 919, Fuke-cho , kameyama, Mie, Japan (hereafter called "**Assignor**") is the owner of the entire right, title, and interest of the patents and patent applications listed in **Exhibit A** attached hereto and referred to as the "**Patents**";

AND WHEREAS, K/S HIMPP, a limited liability company under the laws of Denmark, having a place of business in Lyngø, Denmark, and address at Nymoellevej 6, 3540 Lyngø, Denmark (hereafter called "**Assignee**") wants to acquire the entire right, title and interest in and to said Patents, and all the inventions therein, and Assignor is willing to enter into such assignment;

AND WHEREAS, therefore, the Seller, i.e. the present Assignor, has sold and has thereby undertaken to assign, convey and transfer to the Purchaser, i.e. the present Assignee, the entire right, title and interest in and to the Patents by Patent Purchase Agreement dated December 21, 2022 (the "**Agreement**");

AND WHEREAS Assignor and Assignee are hereinafter together also referred to as the "**Parties**";

NOW THEREFORE, the Parties agree as follows:

1. All capitalized terms not otherwise defined herein, as used in this Assignment, shall have the respective meanings ascribed to such terms in the Agreement.
2. Assignor hereby assigns to Assignee all right, title and interest in, to and under the Patents, including (i) all rights in applications anywhere in the world claiming priority thereto, (ii) all rights to claim priority thereto, (iii) all reissues, continuations, continuations-in-part, divisionals, reexaminations and foreign equivalents thereof, (iv) all letters patent that may be granted on any of the patent applications included therein, (v) all income and payments now or hereafter due or payable with respect thereto, (vi) all causes of action in law or equity relating thereto, and (vii) all rights to sue, counterclaim and recover for past, present and future infringement of the rights assigned, the same to be held and enjoyed by Assignee, its successors and assigns at least as fully and entirely as the same would have been held and enjoyed by Assignor had no sale and assignment of said Patents been made.
3. Assignor further agrees to execute such further documents reasonably required by Assignee to secure and enforce the rights granted to Assignee under this Assignment.
4. Assignee may record this Assignment with the United States Patent and Trademark Office ("**USPTO**") and with comparable offices in other jurisdictions throughout the world. All costs associated with any such registrations or recordations shall be paid by Assignee. Assignor hereby authorizes and requests the Commissioner for Patents of the USPTO, and any official of any country or countries foreign to the United States whose duty is to record documents evidencing ownership of patents and patent applications, to record Assignee as owner of the Patents, including any reissues, continuations, continuations-in-part, divisionals, or reexaminations thereof and foreign equivalents thereto.
5. Assignor hereby authorizes and requests the Commissioner for Patents of the USPTO, and any official of any country or countries foreign to the United States whose duty it is to issue patents

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on applications as aforesaid, to issue all letters patent related to the Assigned Patents to the Assignee, its successors, legal representatives, and assigns, in accordance with the terms of this Assignment.

6. This Assignment shall inure to the benefit of and be binding upon the Parties and their respective successors and permitted assigns.
7. This Assignment is governed by the Laws of Germany. Regarding the interpretation of this Assignment, and disputes related to this Assignment, the Parties agree that the District Court of Munich I has exclusive jurisdiction.
8. This Assignment may be executed in counterparts (including by facsimile or by an electronic scan delivered by electronic mail), each of which shall be deemed an original but all of which together shall be considered one and the same agreement and shall become effective when counterparts have been signed by each Party hereto and delivered to the other Party, it being understood that each Party need not sign the same counterpart. This Assignment may be executed and delivered by facsimile or by an electronic scan delivered by electronic mail.
9. Each of the Assignor and Assignee by its execution of this Assignment hereby acknowledges and agrees that neither the representations and warranties, nor the rights and remedies of the parties under the Agreement shall be deemed to be enlarged, diminished, modified or altered in any way by this Assignment. In the event of any conflict between the Agreement and this Assignment, the terms of the Agreement shall control.

In accordance to the above, the Parties have properly executed this Assignment as per the Effective Date, as provided above.

NITTO DENKO

By: Yoichiro Sugino
Name: Yoichiro Sugino
Title: Vice President
Director, Printed Circuit Div.
Information and Communication Technology
Sector
Date: December 27, 2022

K/S HEMPP

By: Stinus Jeppesen
Name: Stinus Jeppesen
Title: CEO
Date: December 21, 2022

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EXHIBIT A TO PATENT ASSIGNMENT
PATENTS

U.S. PATENTS & APPLICATIONS

Publication Number of Granted Patent	Publication Date of Grant	Application Number	File Date of Application	Status	Title
US10218223	19/02/26	US14/422233	14/05/29	Registered	Portable device, charging system, and power source circuit substrate
US11056920	21/07/06	US16/169342	18/10/24	Registered	Portable device, charging system, and power source circuit substrate
		US17/347277	21/06/14	Unexamined	Portable device, charging system, and power source circuit substrate

NON-U.S. PATENTS & APPLICATIONS

Country	Publication Number of Granted Patent	Publication Date of Grant	Application Number	File Date of Application	Status	Title
JP	JP6381947	18/08/10	JP2014-083538	14/04/15	Registered	携帯機器、充電システム、及び、電源回路基板等
CN	CN104662768	18/05/01	CN201480002419	14/05/29	Registered	PORTABLE DEVICE, CHARGING SYSTEM, POWER SUPPLY CIRCUIT BOARD, ETC.
EP	EP2876777	18/06/27	EP14838760	14/05/29	Registered	PORTABLE DEVICE, CHARGING SYSTEM, POWER SUPPLY CIRCUIT BOARD, ETC.

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KR			KR20157004308	14/05/29	Rejected	PORTABLE DEVICE, CHARGING SYSTEM, POWER SUPPLY CIRCUIT BOARD
SG			SG11201501220R	14/05/29	Ended	PORTABLE DEVICE, CHARGING SYSTEM, POWER SUPPLY CIRCUIT BOARD, ETC.
TW	TWI601431	17/10/01	TW103122730	14/07/01	Ended	<u>Portable</u> <u>electronic</u> <u>device, charging</u> <u>system, power</u> <u>circuit substrate,</u> <u>power supply</u> <u>method, human</u> <u>body wearing</u> <u>device, hearing</u> <u>aid, and power</u> <u>circuit integrated</u> <u>circuit substrate</u>